



July 11, 2011

## C8051F55x-56x-57x Errata

### Errata Status Summary

This document summarizes all known errata with these devices.

| Errata # | Title                                                             | Impact | Revision A                           |
|----------|-------------------------------------------------------------------|--------|--------------------------------------|
| 1        | Cold Programming Temperature on industrial grade (-I) parts only. | Minor  | Issue exists                         |
| 2        | Long-reset Oscillator Lockup                                      | Minor  | Issue resolved from date code "1124" |
| 3        | P0.0 Open-Drain Mode                                              | Minor  | Issue exists                         |

Impact Definition: Each erratum is marked with an impact, as defined below:

- Minor—Workaround exists.
- Major—Errata that do not conform to the data sheet or standard.
- Information—The device behavior is not ideal but acceptable. Typically, the data sheet will be changed to match the device behavior.

### Errata Details

1. **Description:** For -I (Industrial Grade) parts, a cold temperature programming deficiency may be present on weak Flash memory bits. There is no problem programming the Flash at 0 °C and above. There is only a potential Flash read issue if programming was done at cold temperature below 0 °C. If programmed at 0 °C or higher, there is no problem reading Flash across the entire temperature range of -40 °C to 125 °C. This errata does not apply to -A (Automotive Grade) devices.

**Impacts:** Flash bits programmed at temperatures below 0 °C might not read back correctly at elevated temperatures.

**Workaround:** Program the Flash in production and in-system at 0 °C or higher. If programming must be performed at temperatures lower than 0 °C, a validation of the Flash at 25 °C or greater is highly recommended.

**Resolution:** The next revision of the data sheet, revision 1.2, will include a new specification for the valid temperature range to program a device.

2. **Description:** If the /RST pin is held low for more than 1 second while power is applied to the device, and then /RST is released, a percentage of devices may “lock up” and fail to execute code. Toggling the /RST pin does not clear the condition. The condition is cleared by cycling power. Most devices that are affected will show the lock up behavior only within a narrow range of temperatures (a 5 to 10 degrees C window).

**Impacts:** Devices that lock up due to this issue will fail to execute code until the next power-on reset.

**Workaround:** Ensure that the reset low time does not exceed 1 second.

**Resolution:** Silicon Labs has identified a solution to this problem and this solution has been tested and qualified. Parts with the fix do not have any restrictions on /RST low time. The silicon revision remains the same, but Revision A parts that implement the fix can be identified visually using the assembly date code marking on the device. A four-digit assembly build date code is marked on each part on the bottom-most line. This is in the format YYWW, where YY is the two-digit assembly build calendar year and WW is the two-digit assembly build work week. All parts that have an assembly date code of 1124 or later (year 2011, work week 24) do not have any restrictions on /RST low time.

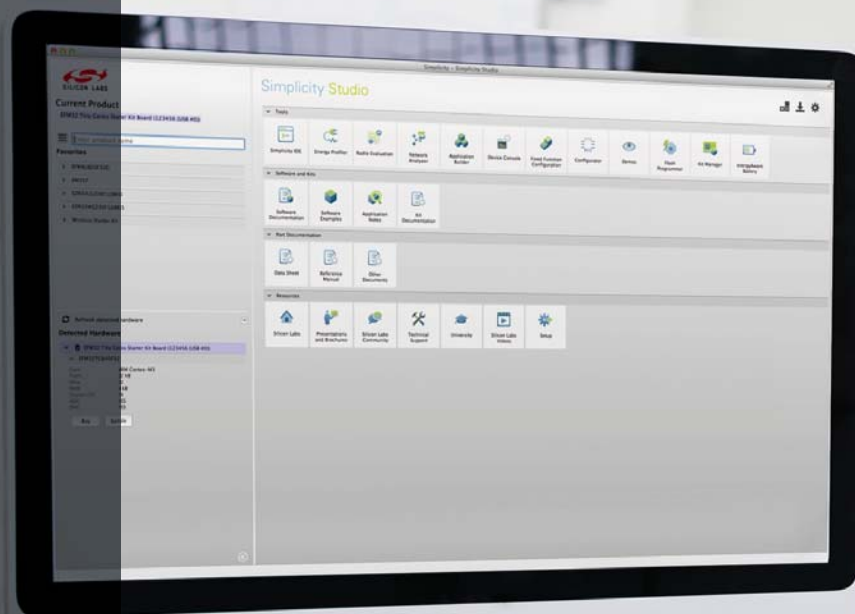
3. **Description:** If VDD is selected as the voltage reference (REF0CN.3 = 1), and the ADC is enabled (ADC0CN.7 = 1), the P0.0/VREF pin cannot operate as a general purpose I/O pin in open-drain mode. With the above settings, this pin can operate in push-pull output mode or as an analog input.

**Impacts:** If the P0.0/VREF pin is configured for open-drain mode with the voltage reference (VREF) set to VDD, the voltage at the pin is indeterminate.

**Workaround:** Ensure that the P0.0 pin is not used in open-drain mode as an input or output.

**Resolution:** The next revision of the data sheet, revision 1.2, will indicate that the conditions under which the P0.0/VREF pin should not be used in open-drain mode.

**Note:** C8051F5xx products are AEC-Q100 compliant and qualification and fault coverage reports are available upon request. A list of Silicon Laboratories sales representatives can be found at [www.silabs.com](http://www.silabs.com). The next revision of the device datasheet will include this note in the relevant sections.



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